

## / Descriptions

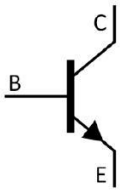
SOT-23          NPN

## / Features

, BC857

## / Applications

## / Equivalent Circuit



## / Pinning

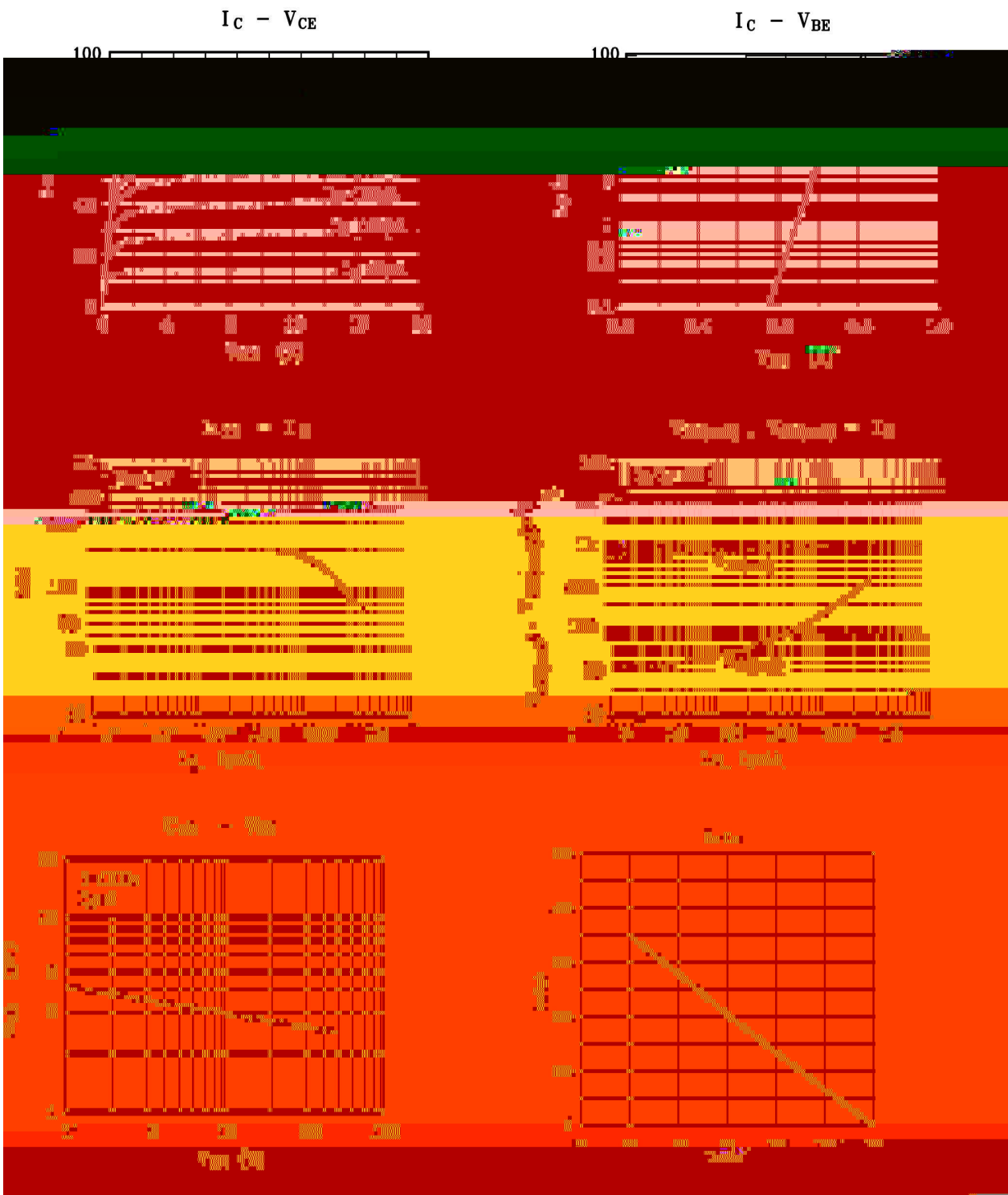


## / $h_{FE}$ Classifications & Marking

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						μ

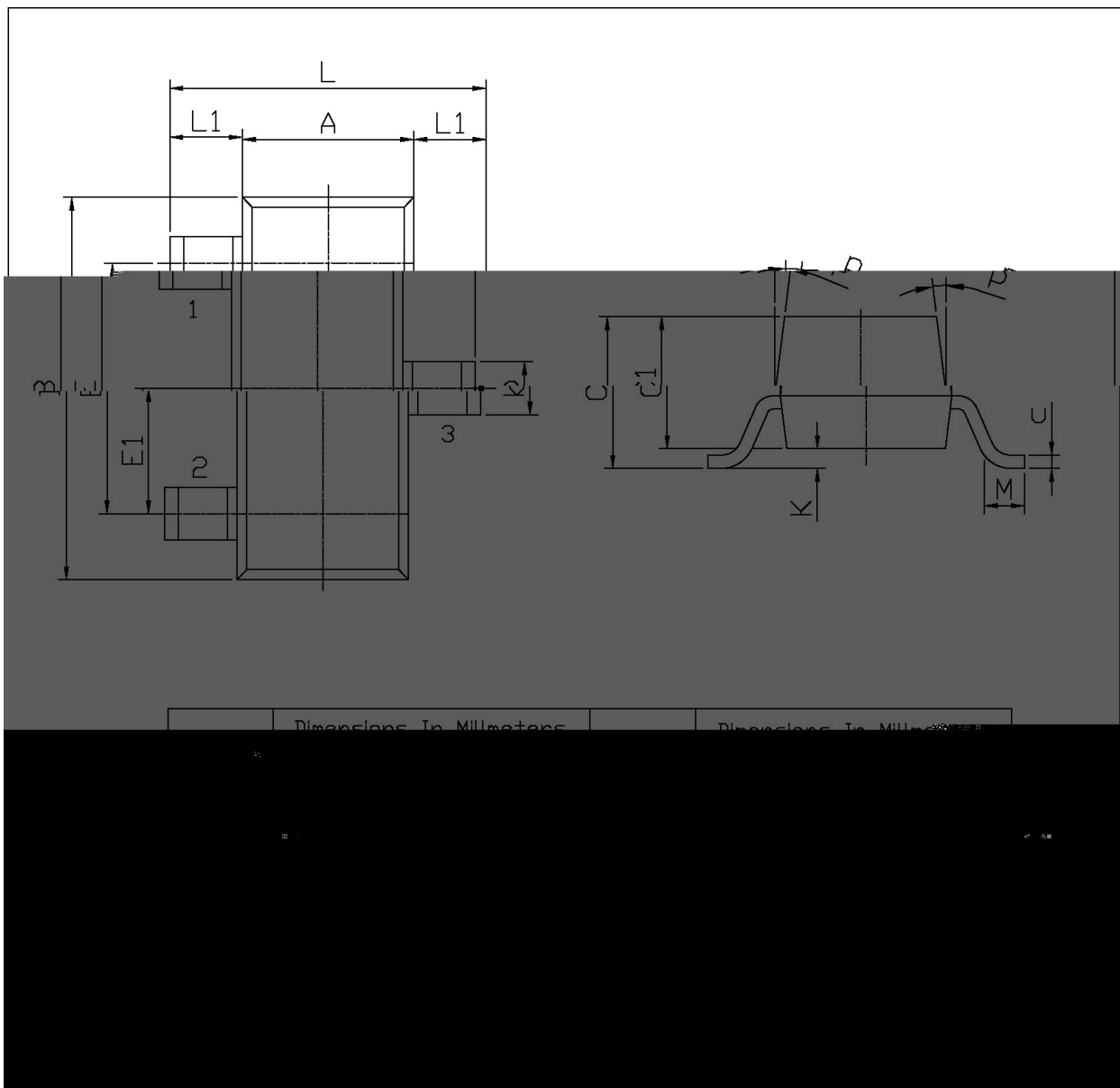
/ Electrical Characteristic Curve



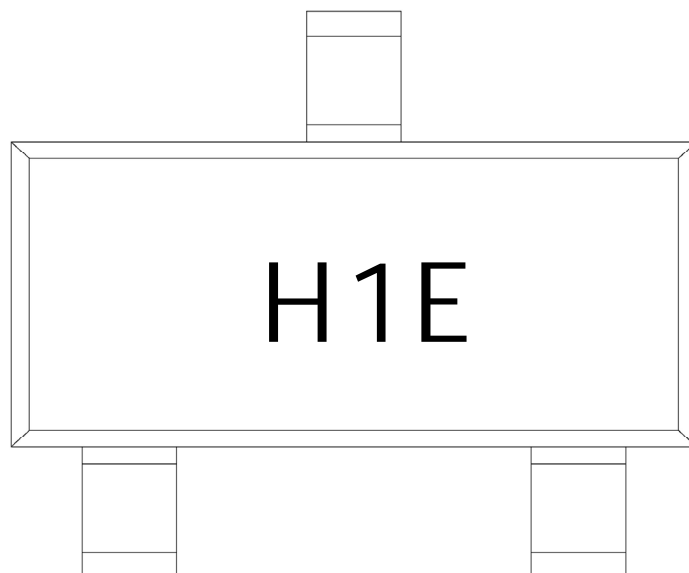
/ Package Dimensions

SOT-23

单位: mm

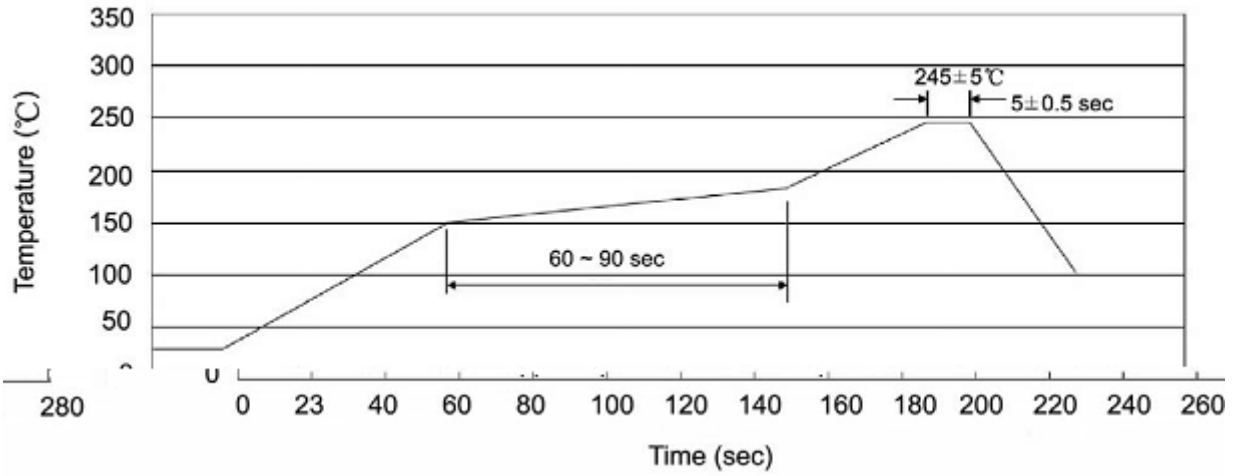


/ Marking Instructions



H  
1E

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸 :		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7 × 8	180×120×180	39×385×205

/ Notices